

RoHS

COMPLIANT HALOGEN

FREE

**Vishay Siliconix** 

# N-Channel 30 V (D-S) MOSFET

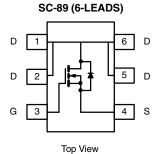
PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ.)			
30	0.099 at V <sub>GS</sub> = 4.5 V	1.2 <sup>a</sup>	3.5			
30	0.140 at $V_{GS}$ = 2.5 V	1.0	0.0			

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

Load Switch for Portable Devices



Marking Code

Ordering Information: Si1070X-T1-GE3 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>A</sub> = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V <sub>DS</sub>	30	v			
Gate-Source Voltage		V <sub>GS</sub>	± 12	v		
	T <sub>A</sub> = 25 °C	1-	1.2 <sup>b, c</sup>			
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T <sub>A</sub> = 70 °C		1 <sup>b, c</sup>			
Pulsed Drain Current		I <sub>DM</sub>	6	- A		
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	9			
Repetitive Avalanche Energy	L = 0.1 IIIH	E <sub>AS</sub>	4.01	mJ		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	۱ <sub>S</sub>	0.2 <sup>b, c</sup>	A		
	T <sub>A</sub> = 25 °C	- P <sub>D</sub> -	0.236 <sup>b, c</sup>	w		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	] ' <sup>D</sup> [	0.151 <sup>b, c</sup>	vv		
Operating Junction and Storage Temperature Ra	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Manimum hunsting to Americanth d	t ≤ 5 s	B	440	530	°C/W	
Maximum Junction-to-Ambient <sup>b, d</sup>	Steady State	R <sub>thJA</sub>	540	650		

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 650  $^{\circ}\text{C/W}.$ 

Document Number: 73893 S10-2542-Rev. D, 08-Nov-10

# Si1070X

# Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		-				
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		24.5		m\//ºC
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{\rm D} = 230 \ \mu \text{A}$		- 3.81		mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$ (			1.55	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA
Zara Cata Valtaga Drain Current	<b>I</b> = • •	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	nA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$			10	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS}$ = $\geq$ 5 V, $V_{GS}$ = 4.5 V	6			Α
	Para	V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 1.2 A		0.082	0.099	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 1.0 A	0.116 0.140		Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 1.2 A		5		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			385		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		55		
Reverse Transfer Capacitance	C <sub>rss</sub>			30		
Tatal Cata Charge	0	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 5 \text{ V}, \text{ I}_{D} = 1.2 \text{ A}$		3.8	8.3	nC
Total Gate Charge	Q <sub>g</sub>			3.5	4.1	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.6 \text{ A}$		1.1		
Gate-Drain Charge	Q <sub>gd</sub>			0.98		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		4.7	6.2	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		22	33	ns
Turn-Off DelayTime	t <sub>d(off)</sub>	$\text{I}_\text{D}\cong$ 1.0 A, $\text{V}_\text{GEN}$ = 4.5 V, $\text{R}_\text{g}$ = 1 $\Omega$		14	21	
Fall Time	t <sub>f</sub>			6	9	
Drain-Source Body Diode Characterist	ics					
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				6	Α
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1.2 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			19.4	29.5	nC
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			18.43	27.5	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 3.8 A, dI/dt = 100 A/μs		16.4		ns
Reverse Recovery Rise Time	t <sub>b</sub>			3		1

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

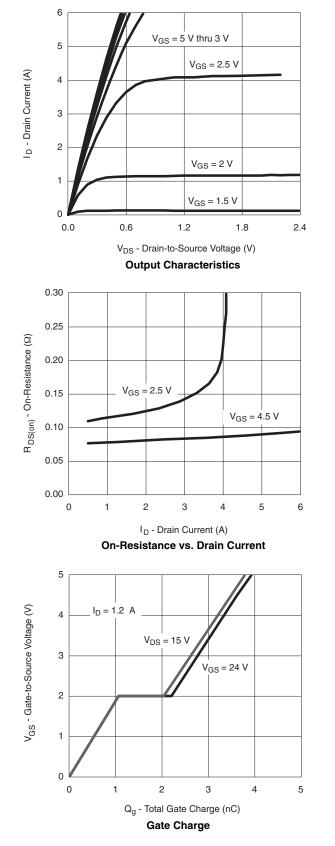
b. Guaranteed by design, not subject to production testing.

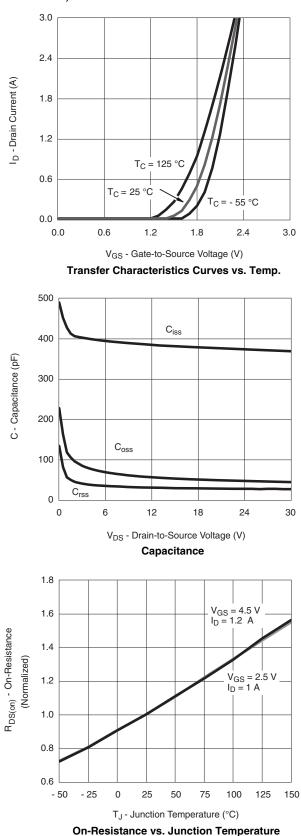
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



### Si1070X Vishay Siliconix

#### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)





Document Number: 73893 S10-2542-Rev. D, 08-Nov-10

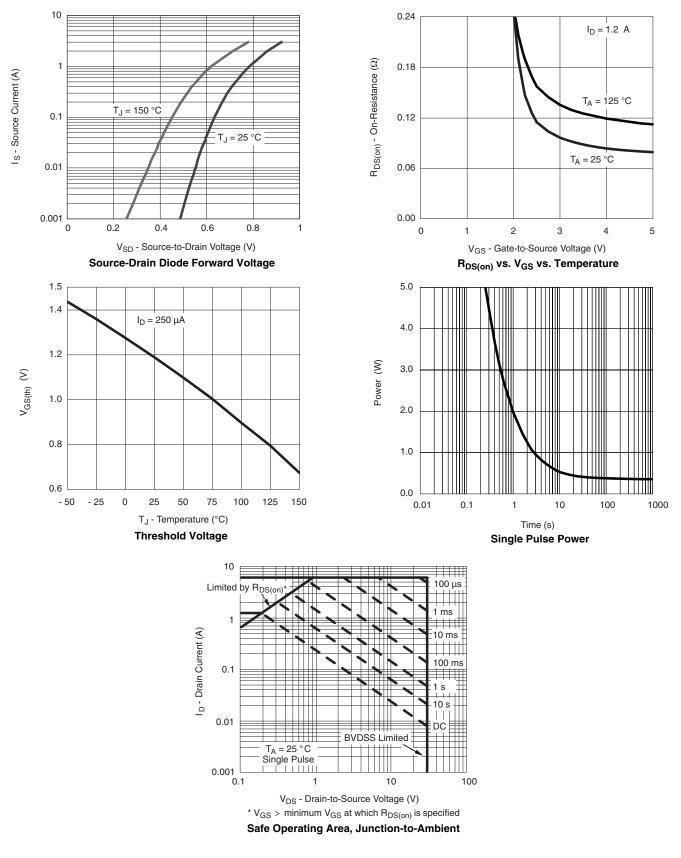
Downloaded from Elcodis.com electronic components distributor

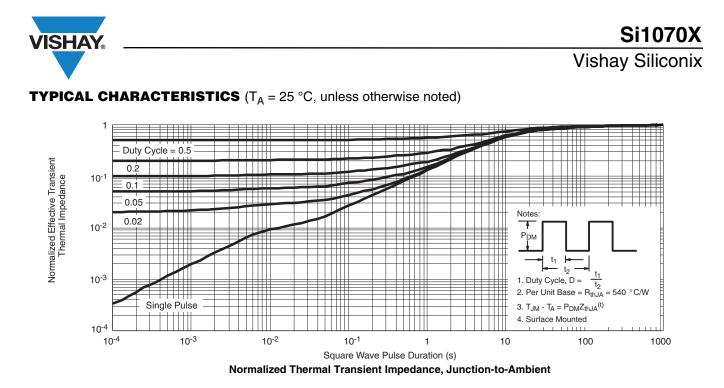
## Si1070X

### Vishay Siliconix



#### **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

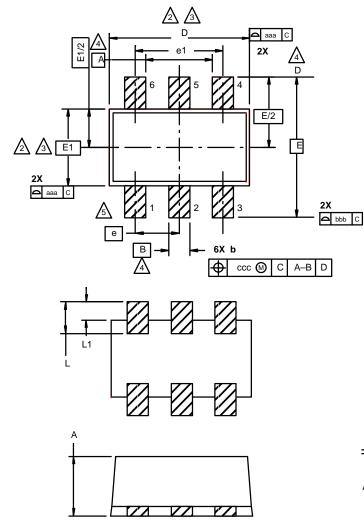




Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?73893">www.vishay.com/ppg?73893</a>.



#### SC89: 6- LEADS (SOT-563F)

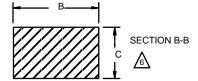


NOTES:

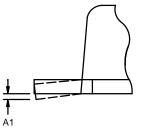
∕₅

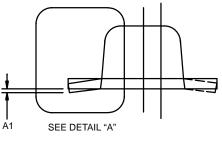
- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- ▲ Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.
- A Datums A, B and D to be determined 0.10 mm from the lead tip.
  - Terminal numbers are shown for reference only.
- These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

Document Number: 71612 25-Jun-01









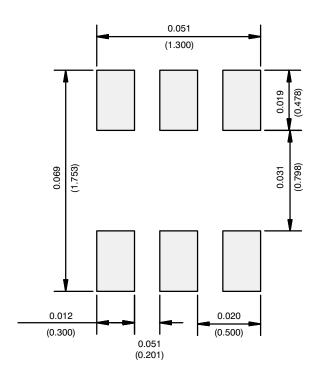
	MILLIMETERS				Tolerances Of Form And	
Dim	Min	Max	Note	Symbol	Position	
Α	0.56	0.60		aaa	0.10	
A1	0.00	0.10		bbb	0.10	
b	0.15	0.30		ссс	0.10	
С	0.10	0.18				
D	1.50	1.70	2, 3			
E	1.55	1.70				
E1	1.20 BSC		2, 3			
е	0.50 BSC					
e1	1.00 BSC					
L	0.35 BSC					
L1	0.20 BSC					
ECN: E-00499—Rev. B, 02-Jul-01 DWG: 5880						



# Application Note 826

Vishay Siliconix

#### **RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.